

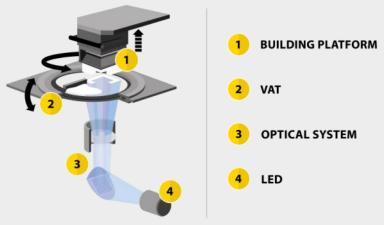
# AIDAinnova WP10 3D printed ceramics

Martin Schwentenwein

#### A closer look at our LCM Technology







Blue light cures the photosensitive formulation

#### **Process Chain**





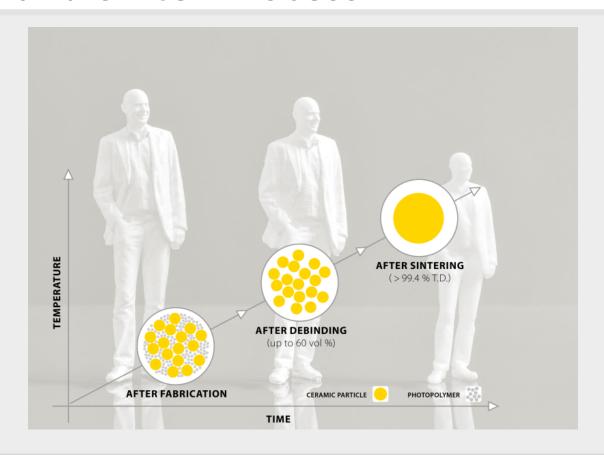




**CAD DESIGN** 

#### **Debind and Sinter Process**









# Aluminum oxide



ID	Material	Number of pieces	Type
E22447	Alumina	7	Plates
E22448	Alumina	7	Plates
A22352	Alumina	6	Discs
A22354	Alumina	9	Discs
A22353	Alumina	8	Discs
A22355	Alumina	7	Discs





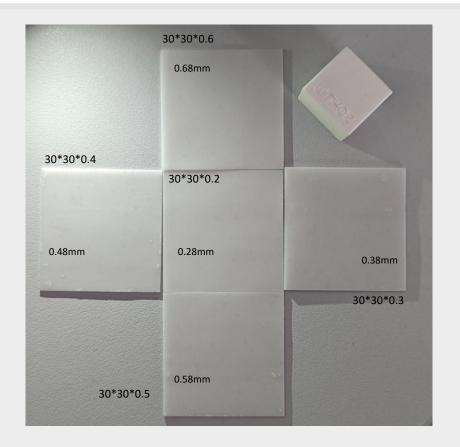


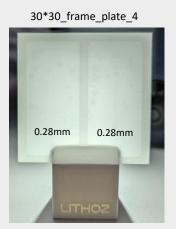


# Aluminum nitride

#### **Aluminium Nitride**







#### **Aluminium Nitride**



- Tailoring of formulation
- Optimization of sintering
  - density of 3.35 g/cm³
  - Thermal conductivity: 212 W/m.K (preliminary)
  - Maximum wall thickness: 4 mm
  - Minimum wall thickness: 0.2 mm
  - Maximum aspect ratio: 10
  - Bending strength: 360 mPa (m = 10)



200µm thin plate

#### Comparison



- Aluminum oxide  $(Al_2O_3)$ :
  - High maturity, robust, and well-commercialized 3D printing process
  - The present limit lies in the building envelope (maximum 190 x  $120 \text{mm}^2$  x,y for the green part).
- Aluminum nitride (AIN):
  - 3D printing process works
  - Warping and deformations induced by the sintering steps are slightly greater for AlN than for  $Al_2O_3$  (higher temperatures + inert atmosphere).
  - The building envelope limit remain the same

#### **Aluminium Nitride**



- Warping/deformation occurs particularly with parts with high aspect ratio such as thin plates;
   potential methods to solve this are:
  - Grinding/Polishing
  - Adaption of sintering method
  - Compensating warping by design (simulation)
  - Avoiding thermal post-processing

# Grinding/Polishing



 Planning of trials with Fraunhofer IKTS from Germany



- Maximum component size that can be grinded under investigation
- Grinding equipment for preparation of test samples was just put into service at Lithoz

## Adaption of sintering method



- Sintering trials with new service provider (FGK from Germany) ongoing
- First runs conducted, characterization pending



# Simulation of debinding/sintering

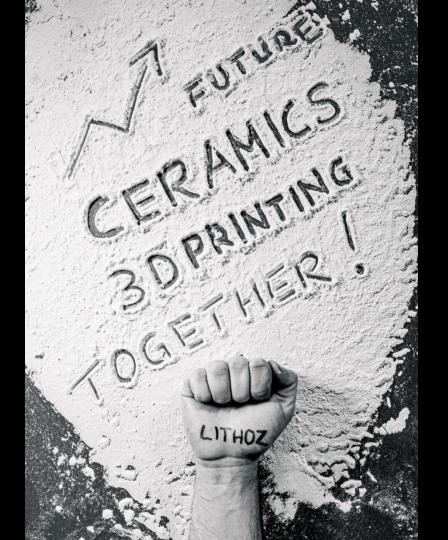


- No activities are planned
  - Are there competencies in the AIDAinnova consortium?

## **Composites**



- Avoiding debinding and sintering -> no shrinkage and thus no (or very limited) deformation
  - Composites based on standard polymer matrix are too soft
  - New polymer matrices only allow lower solids loading with AIN (18vol% vs 44vol%)
  - New Epoxy-based resins will potentially be provided by CERN



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